

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Masanori NARITOMI</td> <td>11/14/2008</td> </tr> <tr> <td>Naoki ANDOH</td> <td>11/17/2008</td> </tr> </tbody> </table>		Name	Execution Date	Masanori NARITOMI	11/14/2008	Naoki ANDOH	11/17/2008
Name	Execution Date						
Masanori NARITOMI	11/14/2008						
Naoki ANDOH	11/17/2008						
RECEIVING PARTY DATA							
Name:	TAISEI PLAS CO., LTD.						
Street Address:	11-8, Nihonbashi-hamacho 1-chome, Chuo-ku,						
City:	Tokyo						
State/Country:	JAPAN						
Postal Code:	103-0007						
PROPERTY NUMBERS Total: 1							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12302130</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12302130		
Property Type	Number						
Application Number:	12302130						
CORRESPONDENCE DATA							
Fax Number:	(202)822-1111						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
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NAME OF SUBMITTER:	Stephen G. Adrian						
Total Attachments: 1 source=082557_Assignment#page1.tif							

OP \$40.00 12302130

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by
TAISEI PLAS CO.,LTD.

(Insert ASSIGNEE's Name(s) Address(es))

11-8, Nihonbashi-hamacho 1-chome, Chuo-ku, Tokyo 103-0007 Japan

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of Invention)

COMPOSITE OF METAL AND RESIN, AND METHOD FOR MANUFACTURING SAME

(*If the assignment is being filed after the filing of the application, this section must be completed)

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

* filed on _____ Serial No. _____

(Westerman, Hattori, Daniels & Adrian, LLP is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)


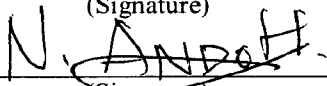
and all Letters Patent of the United States to be obtained therefore on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

 _____ (Signature)	Masanori NARITOMI _____ (Type Name)	<u>18 Nov 2008</u> _____ (Date)
 _____ (Signature)	Naoki ANDOH _____ (Type Name)	<u>17. Nov. 2008</u> _____ (Date)
_____ (Signature)	_____ (Type Name)	_____ (Date)
_____ (Signature)	_____ (Type Name)	_____ (Date)
_____ (Signature)	_____ (Type Name)	_____ (Date)
_____ (Signature)	_____ (Type Name)	_____ (Date)

NO LEGALIZATION REQUIRED

PATENT